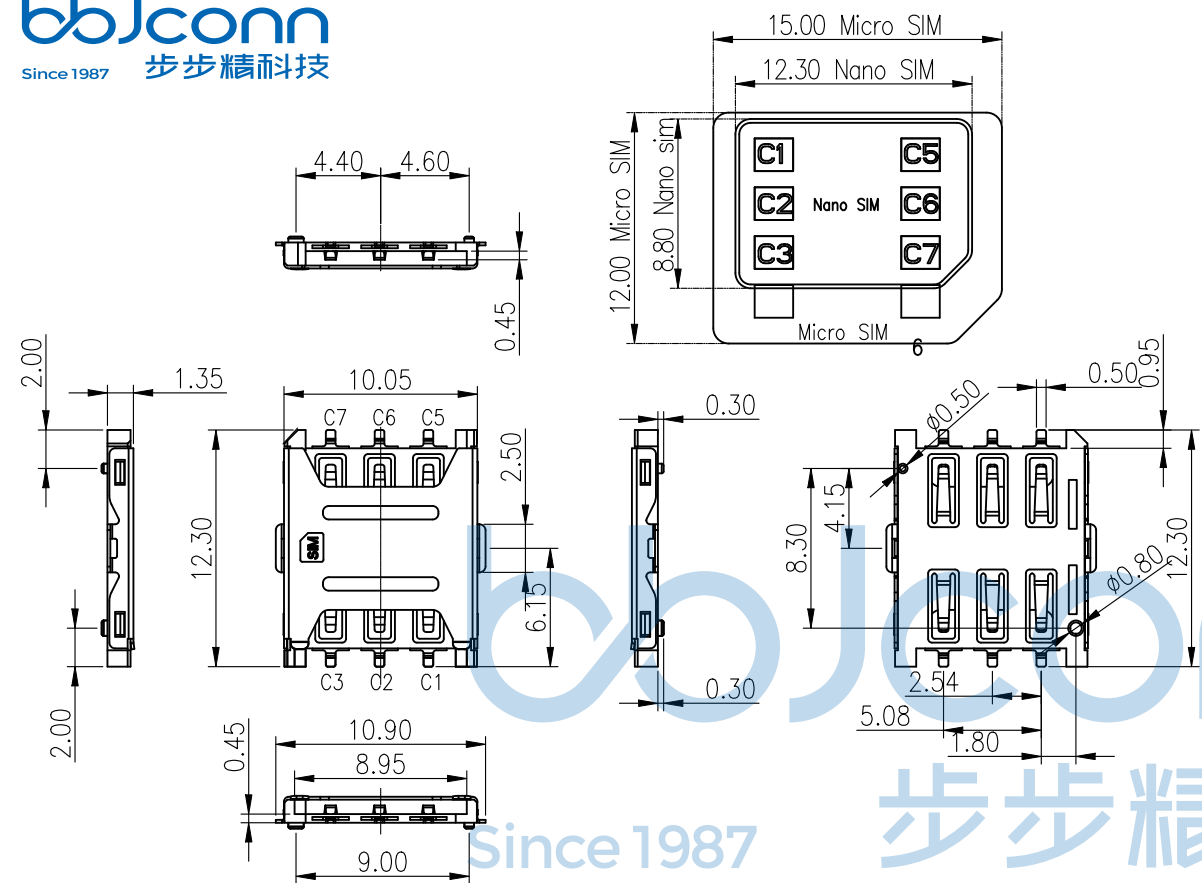
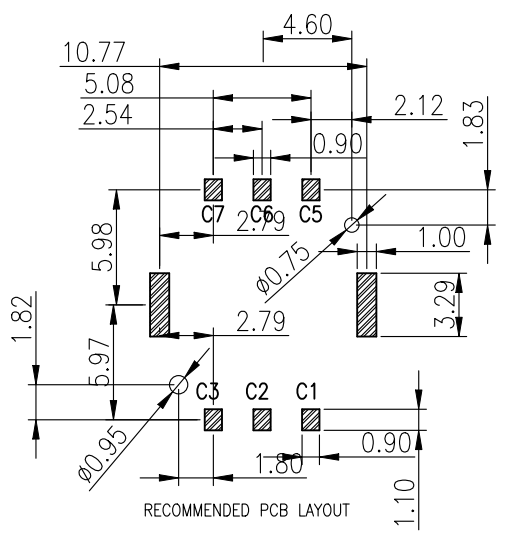


REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



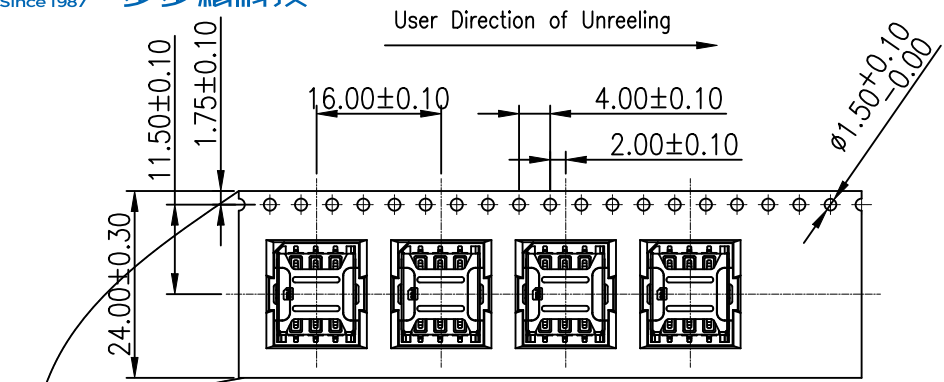
- NOTES:
- MATERIAL:
 - INSULATOR: LCP UL94V-0;BLACK.
 - TERMINAL: COPPER ALLOY.
 - SHELL: STAINLESS STEEL.
 - PLATING:
 - CONTACT: 30U" NI UNDERPLATED OVERALL
G/F PLATED ON CONTACT AREA & SOLDER AREA
 - SPECIALITY:
 - CURRENT RATING :0.5A
 - VOLTAGE RATING :30V DC
 - AMBIENT TEMPERATURE RANGE :-20°C~+60°C
 - STORAGE TEMPERATURE RANGE :-40°C~+70°C
 - AMBIENT HUMIDITY RANGE :95% R.H. MAX.
 - CONTACT RESISTANCE:100MΩ MAX.
 - INSULATION RESISTANCE:1000MΩ MIN./500VDC
 - MATING CYCLES:5,000 INSERTIONS
 - REFLOW PEAK TEMP.:260°C ±5°C, 3~5 S
 - MATING CYCLES:3,000 INSERTIONS MIN

SIM pin assignment	
PIN#	Name
C1	VCC供电电压
C2	RST重置
C3	CLK时钟
C5	GND接地
C6	VPP程序电压
C7	I/O输入输出

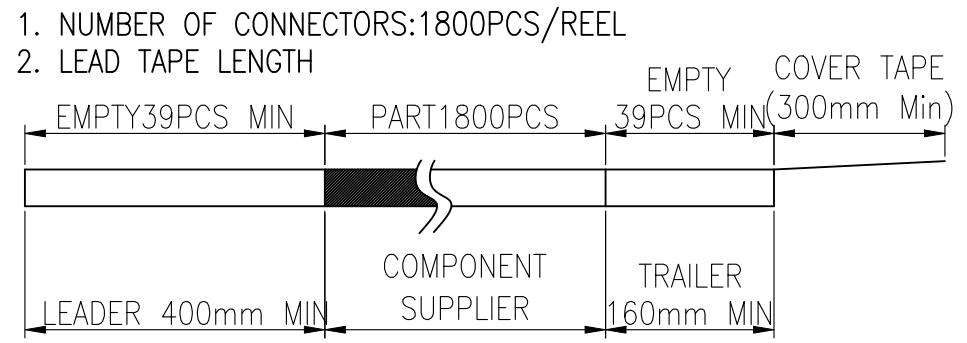


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CORPORATION AND SHOULD NOT BE USED IN WHOLE OR IN PART WITHOUT PRIOR WRITTEN PERMISSION.		NAME: 卡座 SIM NANO SIM PUSH PULL 6PIN H=1.35 贴片 有柱	
APPD.	JM_Zheng	PJ. NO.: 142-201-060002-V8G	
CHKD.	LYX	SIZE: A4 DRW NO.:	
PDWG.NO:	0302-1	FINISH: SEE NOTES MAT'L.: SEE NOTES	
DR.	TSP	SCALE: N/A	REV.: A0 UNIT: mm PAGE: 1/2

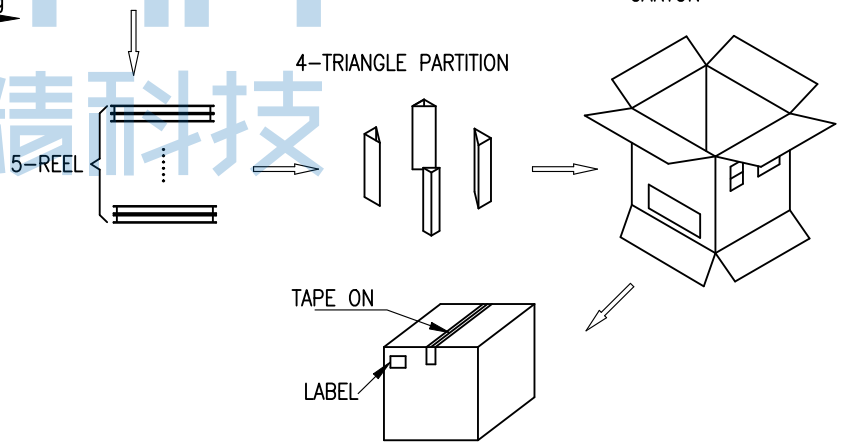
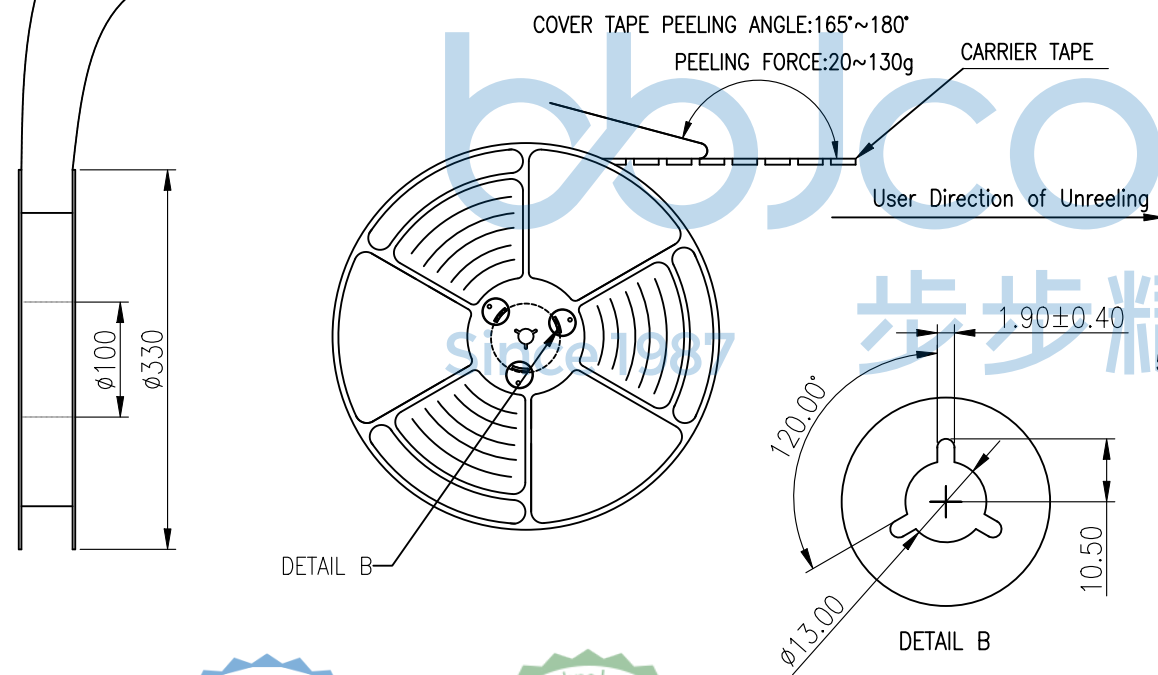
REV.	ECN NO	CONTENT	DATE	ENGINEER
A0		Initial release	/	TSP



NOTES



3. QUANTITY: 9000PCS/CARTON



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APPD.	JM_Zheng	PJ. NO.: 142-201-060002-V8G SIZE: A4 DRW NO.:		FINISH: SEE NOTES MAT'L.: SEE NOTES	
CHKD.	LYX	SCALE: N/A		REV.: A0	UNIT: mm
PDWG.NO:	0302-1	DR.	TSP	PAGE: 2/2	